



Date: 29th September, 2026

To The General Manager Department of Corporate Services BSE Ltd, P. J. Towers, Dalal Street, Mumbai – 400 001 Scrip code: 532407	To The Listing Department National Stock Exchange of India Limited Exchange Plaza, Bandra Kurla Complex, Mumbai – 400 051 Scrip Symbol: MOSCHIP
---	--

Dear Sir/ Madam,

Sub: Submission of copy of CEO presentation presented in 27th Annual General Meeting of the Company.

Pursuant to Regulation 30 of SEBI (Listing Obligations & Disclosure Requirements) Regulations, 2015, we are enclosing herewith the CEO presentation presented to the shareholders of the Company in 27th Annual General Meeting held today i.e. 29th September, 2026.

You are requested to kindly take the same on record.

Yours truly,
For MOSCHIP TECHNOLOGIES LIMITED

Suresh
Bachalakura
Suresh Bachalakura
Company Secretary

Digitally signed by
Suresh Bachalakura
Date: 2026.09.29
20:15:54 +05'30'

Encl.: As above

MosChip's 27th Annual General Meeting - Sept 29th, 2026

Srinivasa Rao Kakumanu

MD&CEO

Agenda

- FY26 Performance and Recent History
- Business Units and their performance summary
- Highlights of FY26
- Industry Outlook and Growth Opportunities
- Looking Ahead...
- MosChip at Industry events and CSR Initiatives
- Other Highlights (Operations)

Reflecting on FY26



Revenue:

- Revenue from Operations grew from **INR 466.84 Cr** in FY25 to **585.15Cr** in FY26. Grew by **25.34% Y-o-Y**
- Profit-Before-Tax (PBT) grew from **INR 33.53 Cr** in FY25 to **INR 41.58 Cr** in FY26



New Customers:

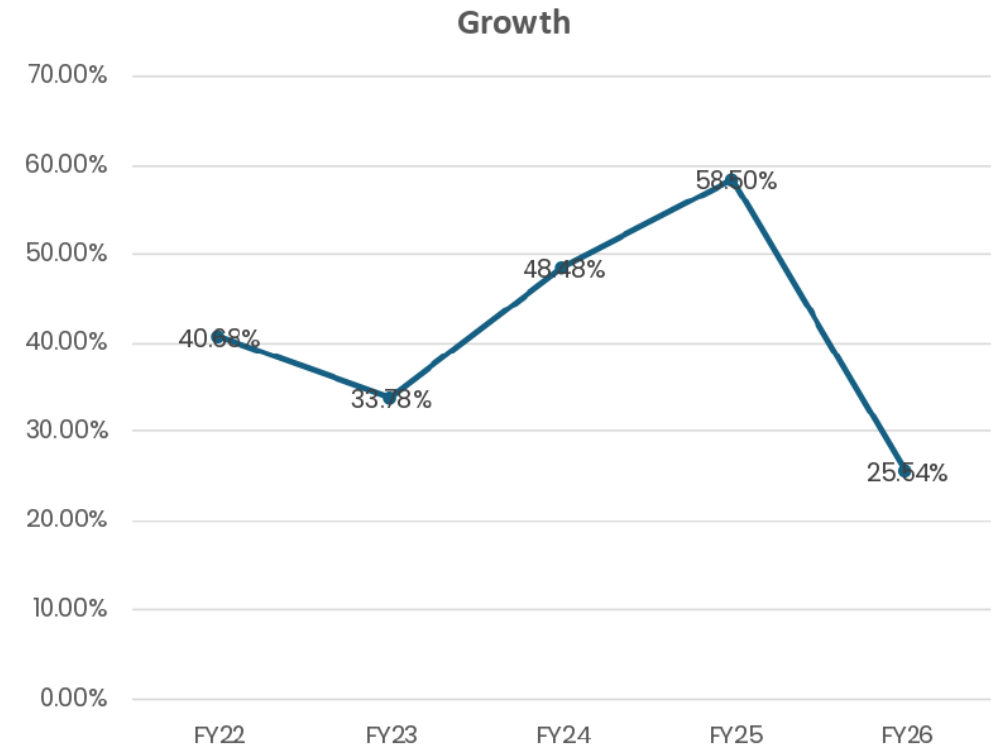
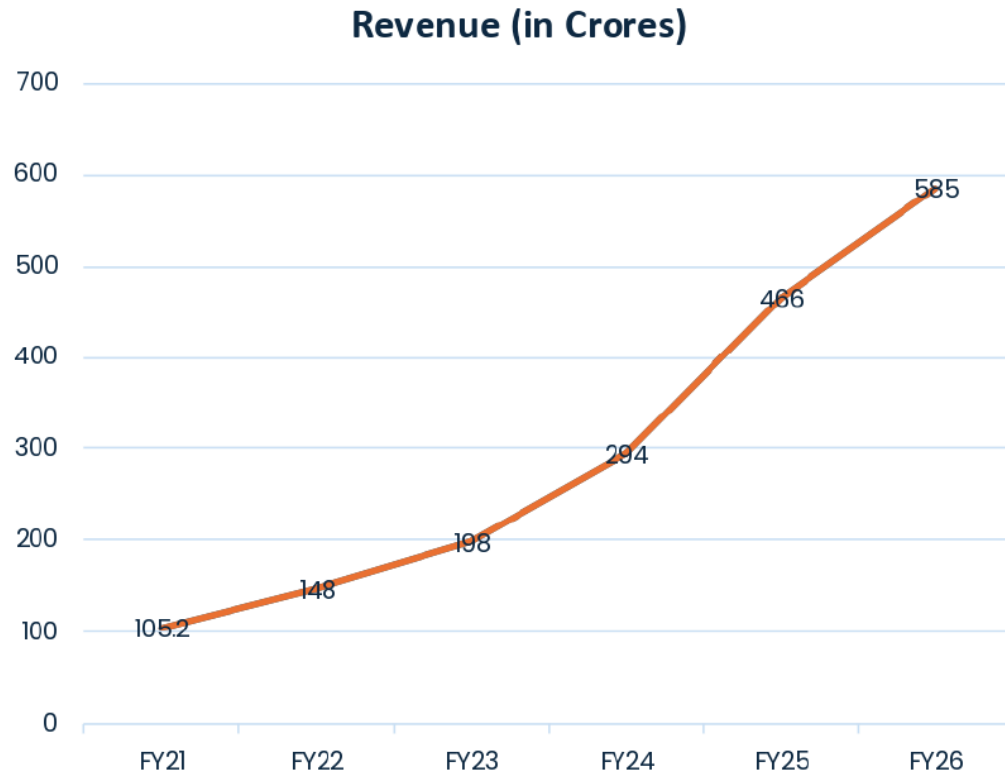
- Added 12 new customers. Expanded customer base to Australia, Europe, Japan, and South Korea



Leadership:

- Continued to strengthen leadership in Engineering, Business Development and Operations

Reflecting on FY26 (FY21-FY26 Growth snapshot)



Growing at a CAGR of 41% since FY22

Business Units/Focus Areas

Silicon Engineering BU

IP Services

Semiconductor
Design Services

Turn-key ASIC

Product Engineering BU

Product /
System Design

Embedded
Software

Digital
Engineering

MAST (Training and Innovation centre to support R&D & growth plans)

Highlights of FY26

- MosChip delivers a custom SOC to ISRO's Space Application Centre (SAC) for India's Satellite Navigation Program



- MosChip Collaborates with EMASS on Silicon Implementation for its Breakthrough Edge AI SoC



- MosChip has been involved in about 100 tape outs (including test chips, respins and derivative chips) in legacy and advanced technology nodes across different Fabs in FY26
- MosChip has secured project wins for Product Engineering BU from two Fortune 500 companies who are in top 50.

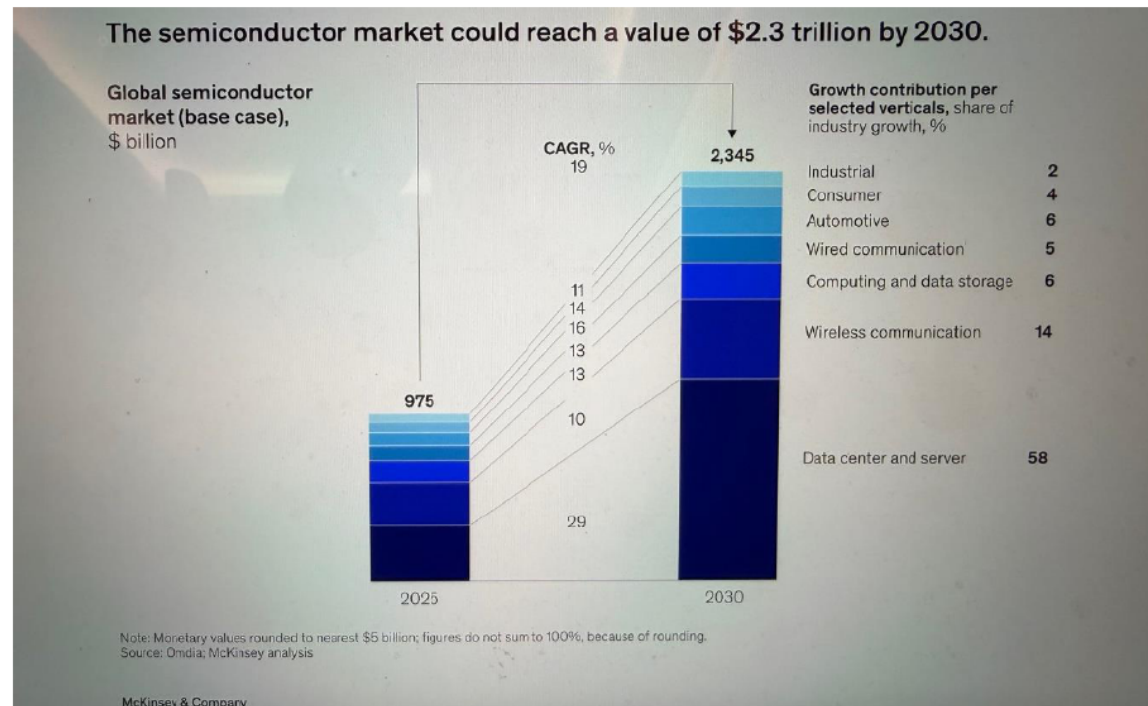
Highlights of FY26

- The indigenous HPC (High Performance Computing Processor) in 5nm technology that MosChip is building for C-DAC in collaboration with Socionext is progressing well and is taping out soon
- The smart energy meter IC (VIDYUT) that MosChip is developing under DLI (Design Linked Incentive) scheme was taped out and is back in the Lab. The initial bring-up results are promising and further bring-up and validation is underway



Industry Outlook and Growth Opportunities

- The industry environment continues to be highly encouraging for companies operating in semiconductor and product engineering
- The global semiconductor industry is witnessing strong demand driven by
 - Artificial Intelligence, IoT, 6G, Autonomous mobility
 - High-performance computing, Data centres
 - Industrial automation, connected devices and digital transformation across sectors



Industry Outlook and Growth Opportunities

- With our capabilities in Silicon Engineering, Embedded Systems and Product Engineering, MosChip is well positioned to participate in these long-term structural growth opportunities
- India's semiconductor ecosystem is also witnessing unprecedented momentum, supported by policy initiatives, growing domestic demand, global supply chain diversification and increasing investments in electronics and semiconductor design
- As an Indian semiconductor and product engineering company with global delivery capabilities, MosChip is committed to contributing to this national opportunity by building high-quality engineering talent, developing advanced design capabilities, creating intellectual property and supporting customers across the semiconductor and digital product lifecycle

Looking Ahead...

- Looking ahead, our priorities remain clear.
 - We will continue to deepen relationships with strategic customers
 - Expand our presence in key international markets
 - Scale our Product Engineering Services and Turnkey ASIC businesses
 - Strengthen our leadership in Silicon and Digital/AI engineering
 - Invest in talent, infrastructure, innovation and AI adoption
 - We will also remain focused on execution discipline, operational efficiency, customer satisfaction, prudent capital allocation and sustainable value creation

Events & Keynotes



We were extremely delighted and honoured to interact and present our silicon design capability to Shri [@ashwini.vaishnaw](#), Hon'ble Minister, [@goi meity](#); Railways and Information & Broadcasting, [@mygovindia](#), at the interactive session for semiconductor chip design companies under the Design Linked Incentive (DLI) scheme.



MosChip Technologies, USA is at the TSMC NA 2025 Technology Symposium



Team MosChip is live at the NASSCOM Design & Engineering Summit 2025 in Bangalore!



MosChip at the Semicon India Conference 2025



Swamy Irrinki, EVP - worldwide sales & Marketing



Industry Forum on ASICs to AgenticAI-Powering the next wave of Intelligent systems by Vishal Patil, SVP – Product Engineering BU

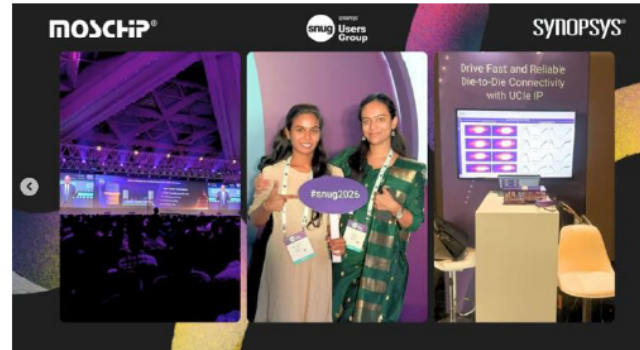
Events & Keynotes



Our CFO, Jayaram Susarla, in the latest CXO Leadership Forum shares how technology and data are transforming finance leaders into strategic business enablers - driving insight, agility, and growth.



Great showcasing our AI-powered medicine box built on the Infineon PSoC™ Edge E84 at Embedded World 2026 in Nuremberg. The demo highlighted how Edge AI can enable smarter, more responsive healthcare devices - bringing intelligence directly to the device for faster and more reliable outcomes.
www.moschip.com



@MosChip® is excited to share that our engineers, Sai Lakshmi Gurram, will present on HBM3 IP Integration & Implementation-Strategies for Seamless Execution, and Sivani Yarrarapu will present on Architectural Integration of a Unified Coherent UCle Subsystem in a 96-Core Multi-Die SoC at [#SNUG2026](#).



Shaping the Future of Electronics & Semiconductors in Pune & Maharashtra. Meet Vishal Patil at SemiconTantra Conference 2026.



Nagi Reddy Chitta, AVP- Embedded Systems from MosChip® delivered a keynote address about porting AI to Cadence Vision DSP at CadenceLIVE 2026 event, held in [Japan](#).

Corporate Social Responsibility [CSR]



60 student tables and 4 interactive flat panels, Enhancing classroom infrastructure and digital learning facilities, University College of Engineering, Osmania University, Hyderabad



3 interactive digital panels, Strengthening digital and interactive learning in classrooms, Saraswathi Vidya Mandir High School, Hyderabad



MosChip® Technologies is proud to support the training of [#India's](#) [#Olympic](#) and [#Paralympic](#) athletes through our association with OGQ (Olympic Gold Quest).



Sports equipment and support towards sports infrastructure, training camps and coaching programmes, Promoting sports, physical fitness, leadership and grassroots development among children from economically weaker sections, Sports Coaching Foundation, Hyderabad

MosChip Academy of Silicon Systems and Technologies [MAST] Initiatives



Toast Master Session - Weekly



Trainee of the Month – Conducted Monthly for all Domains



Communication Classes – Conducted Quarterly



VLSI – Pathway Workshop for Parents



Industry Institute Interaction (i3) Initiative Season 3 Program held in MosChip Academy

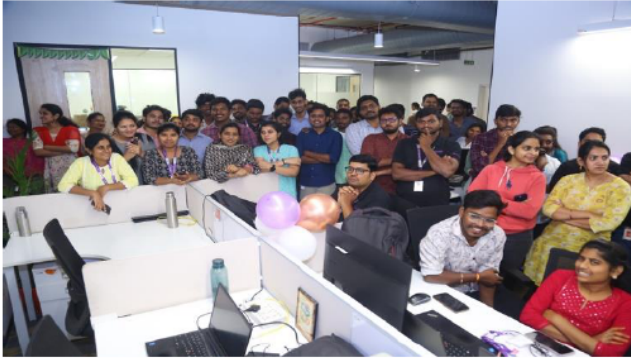


Industry Institute Interaction (i3) Initiative Season 4 Program held in MosChip Academy



Industry Institute Interaction (i3) Initiative Season 5 Program held in MosChip Academy

Other Highlights



26 Years of Innovation | MosChip®



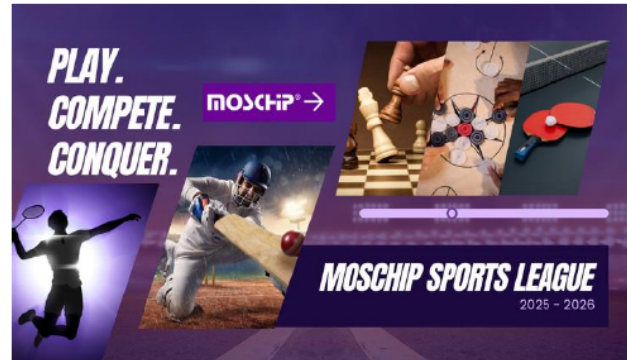
It was a high-octane performance by the boys and girls at the MosChip Sports League



Excited to announce that our new office in Pune is now open - a milestone that reflects MosChip's continuous growth and commitment to innovation.



Mr. Srinivasa Kakumanu, our CEO & MD was honored with the Distinguished Alumni Award - 2025 by the University College of Engineering, Osmania University for his outstanding contributions to industry and academia.



We are trading laptops for leaderboards as we get ready for another thrilling season of MosChip Sports League (MSL). Stay tuned for all the updates- from carrom to cricket to badminton...the fun is about to begin!

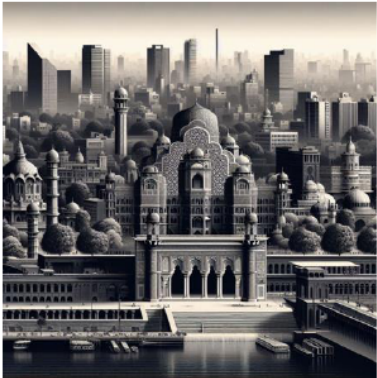


New year. New space. New energy. January marked an exciting new chapter for MosChip as we moved into our new Bengaluru office - an important milestone in our growth journey.



Let's Connect

www.moschip.com | contact@moschip.com



Ahmedabad



Bengaluru



Hyderabad (HQ)



Pune



Santa Clara - USA